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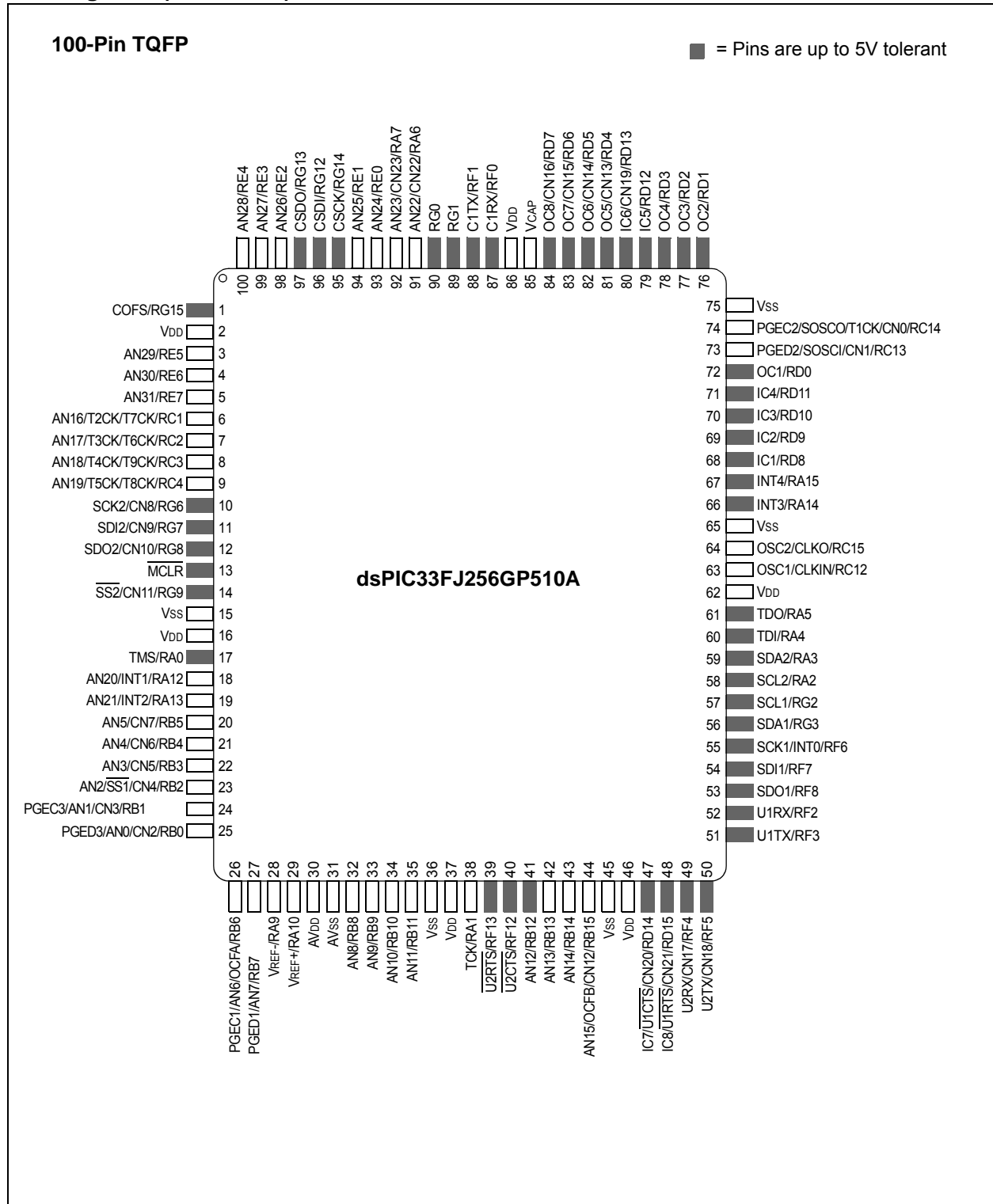
### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	40 MIPS
Connectivity	I <sup>2</sup> C, IrDA, LINbus, SPI, UART/USART
Peripherals	AC'97, Brown-out Detect/Reset, DMA, I <sup>2</sup> S, POR, PWM, WDT
Number of I/O	85
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 32x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (12x12)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/dspic33fj128gp310a-e-pt">https://www.e-xfl.com/product-detail/microchip-technology/dspic33fj128gp310a-e-pt</a>

# dsPIC33FJXXXGPX06A/X08A/X10A

## Pin Diagrams (Continued)

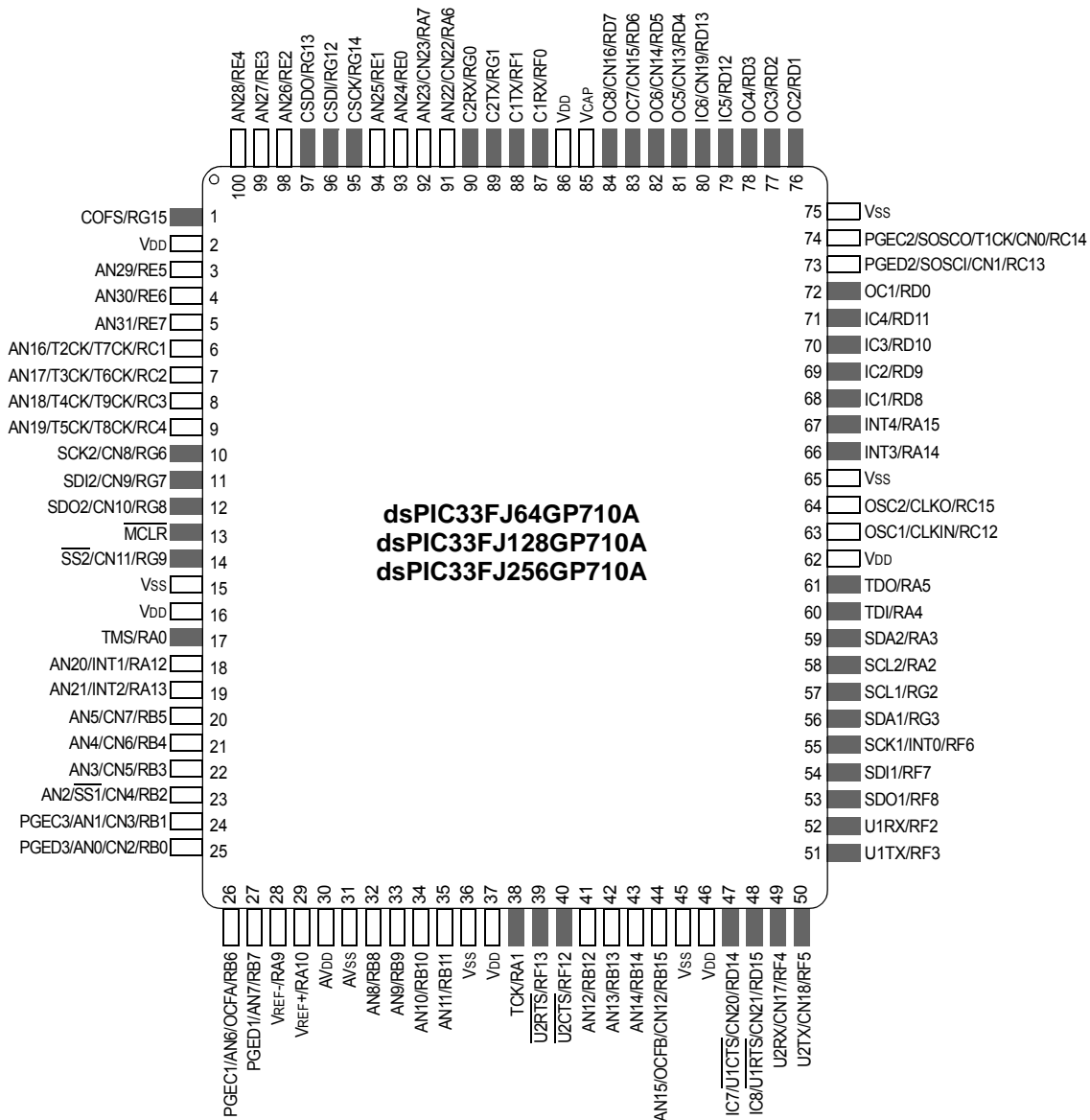


# dsPIC33FJXXXGPX06A/X08A/X10A

## Pin Diagrams (Continued)

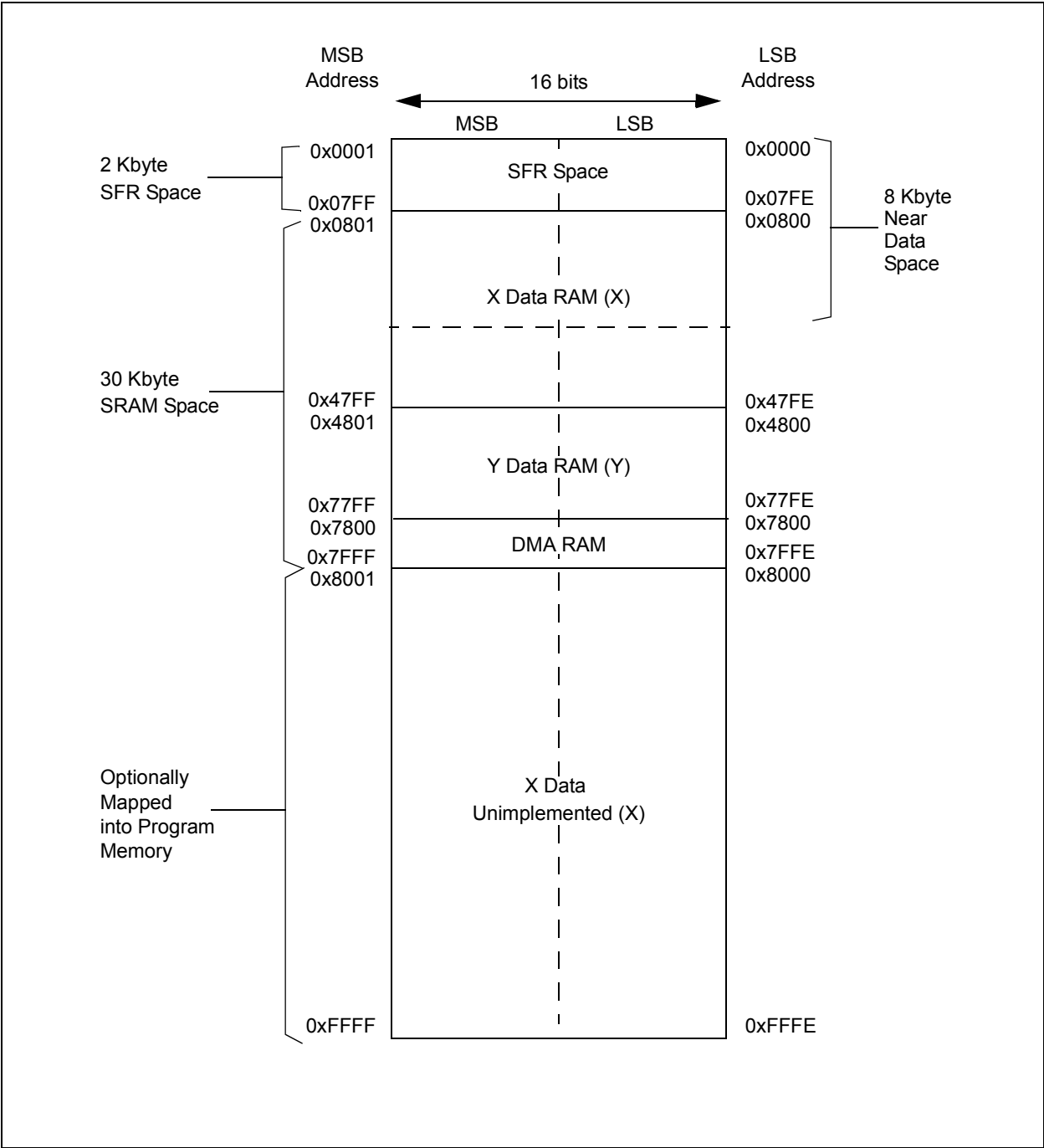
### 100-Pin TQFP

■ = Pins are up to 5V tolerant



# dsPIC33FJXXXGPX06A/X08A/X10A

FIGURE 4-5: DATA MEMORY MAP FOR dsPIC33FJXXXGPX06A/X08A/X10A DEVICES WITH 30 KBS RAM



**TABLE 4-9: I2C1 REGISTER MAP**

SFR Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
I2C1RCV	0200	—	—	—	—	—	—	—	—	Receive Register								0000
I2C1TRN	0202	—	—	—	—	—	—	—	—	Transmit Register								00FF
I2C1BRG	0204	—	—	—	—	—	—	—	Baud Rate Generator Register								0000	
I2C1CON	0206	I2CEN	—	I2CSIDL	SCLREL	IPMIEN	A10M	DISSLW	SMEN	GCEN	STREN	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	1000
I2C1STAT	0208	ACKSTAT	TRSTAT	—	—	—	BCL	GCSTAT	ADD10	IWCOL	I2COV	D_A	P	S	R_W	RBF	TBF	0000
I2C1ADD	020A	—	—	—	—	—	—	Address Register										0000
I2C1MSK	020C	—	—	—	—	—	—	Address Mask Register										0000

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-10: I2C2 REGISTER MAP**

SFR Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets	
I2C2RCV	0210	—	—	—	—	—	—	—	—	Receive Register									0000
I2C2TRN	0212	—	—	—	—	—	—	—	—	Transmit Register									00FF
I2C2BRG	0214	—	—	—	—	—	—	—	Baud Rate Generator Register										0000
I2C2CON	0216	I2CEN	—	I2CSIDL	SCLREL	IPMIEN	A10M	DISSLW	SMEN	GCEN	STREN	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	1000	
I2C2STAT	0218	ACKSTAT	TRSTAT	—	—	—	BCL	GCSTAT	ADD10	IWCOL	I2COV	D_A	P	S	R_W	RBF	TBF	0000	
I2C2ADD	021A	—	—	—	—	—	—	Address Register										0000	
I2C2MSK	021C	—	—	—	—	—	—	Address Mask Register										0000	

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-24: DCI REGISTER MAP

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
DCICON1	0280	DCIEN	—	DCISIDL	—	DLOOP	CSCKD	CSCKE	COFSD	UNFM	CSDOM	DJST	—	—	—	COFSM1	COFSM0	0000 0000 0000 0000
DCICON2	0282	—	—	—	—	BLEN1	BLEN0	—	COFSG<3:0>				—	WS<3:0>				0000 0000 0000 0000
DCICON3	0284	—	—	—	—	BCG<11:0>												0000 0000 0000 0000
DCISTAT	0286	—	—	—	—	SLOT3	SLOT2	SLOT1	SLOT0	—	—	—	—	ROV	RFUL	TUNF	TMPTY	0000 0000 0000 0000
TSCON	0288	TSE15	TSE14	TSE13	TSE12	TSE11	TSE10	TSE9	TSE8	TSE7	TSE6	TSE5	TSE4	TSE3	TSE2	TSE1	TSE0	0000 0000 0000 0000
RSCON	028C	RSE15	RSE14	RSE13	RSE12	RSE11	RSE10	RSE9	RSE8	RSE7	RSE6	RSE5	RSE4	RSE3	RSE2	RSE1	RSE0	0000 0000 0000 0000
RXBUF0	0290	Receive Buffer #0 Data Register																0000 0000 0000 0000
RXBUF1	0292	Receive Buffer #1 Data Register																0000 0000 0000 0000
RXBUF2	0294	Receive Buffer #2 Data Register																0000 0000 0000 0000
RXBUF3	0296	Receive Buffer #3 Data Register																0000 0000 0000 0000
TXBUF0	0298	Transmit Buffer #0 Data Register																0000 0000 0000 0000
TXBUF1	029A	Transmit Buffer #1 Data Register																0000 0000 0000 0000
TXBUF2	029C	Transmit Buffer #2 Data Register																0000 0000 0000 0000
TXBUF3	029E	Transmit Buffer #3 Data Register																0000 0000 0000 0000

**Legend:** — = unimplemented, read as '0'.

**Note 1:** Refer to the "dsPIC33F/PIC24H Family Reference Manual" for descriptions of register bit fields.

TABLE 4-25: PORTA REGISTER MAP<sup>(1)</sup>

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TRISA	02C0	TRISA15	TRISA14	TRISA13	TRISA12	—	TRISA10	TRISA9	—	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	F6FF
PORTA	02C2	RA15	RA14	RA13	RA12	—	RA10	RA9	—	RA7	RA6	RA5	RA4	RA3	RA2	RA1	RA0	xxxx
LATA	02C4	LATA15	LATA14	LATA13	LATA12	—	LATA10	LATA9	—	LATA7	LATA6	LATA5	LATA4	LATA3	LATA2	LATA1	LATA0	xxxx
ODCA <sup>(2)</sup>	06C0	ODCA15	ODCA14	—	—	—	—	—	—	—	—	ODCA5	ODCA4	ODCA3	ODCA2	ODCA1	ODCA0	0000

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal for PinHigh devices.

**Note 1:** The actual set of I/O port pins varies from one device to another. Please refer to the corresponding pinout diagrams.

TABLE 4-26: PORTB REGISTER MAP<sup>(1)</sup>

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TRISB	02C6	TRISB15	TRISB14	TRISB13	TRISB12	TRISB11	TRISB10	TRISB9	TRISB8	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	FFFF
PORTB	02C8	RB15	RB14	RB13	RB12	RB11	RB10	RB9	RB8	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx
LATB	02CA	LATB15	LATB14	LATB13	LATB12	LATB11	LATB10	LATB9	LATB8	LATB7	LATB6	LATB5	LATB4	LATB3	LATB2	LATB1	LATB0	xxxx

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal for PinHigh devices.

**Note 1:** The actual set of I/O port pins varies from one device to another. Please refer to the corresponding pinout diagrams.

## REGISTER 7-5: IFS0: INTERRUPT FLAG STATUS REGISTER 0 (CONTINUED)

bit 2	<b>OC1IF:</b> Output Compare Channel 1 Interrupt Flag Status bit 1 = Interrupt request has occurred 0 = Interrupt request has not occurred
bit 1	<b>IC1IF:</b> Input Capture Channel 1 Interrupt Flag Status bit 1 = Interrupt request has occurred 0 = Interrupt request has not occurred
bit 0	<b>INT0IF:</b> External Interrupt 0 Flag Status bit 1 = Interrupt request has occurred 0 = Interrupt request has not occurred

## REGISTER 7-7: IFS2: INTERRUPT FLAG STATUS REGISTER 2 (CONTINUED)

- bit 2      **C1RXIF:** ECAN1 Receive Data Ready Interrupt Flag Status bit  
            1 = Interrupt request has occurred  
            0 = Interrupt request has not occurred
- bit 1      **SPI2IF:** SPI2 Event Interrupt Flag Status bit  
            1 = Interrupt request has occurred  
            0 = Interrupt request has not occurred
- bit 0      **SPI2EIF:** SPI2 Error Interrupt Flag Status bit  
            1 = Interrupt request has occurred  
            0 = Interrupt request has not occurred



# dsPIC33FJXXGPX06A/X08A/X10A

## REGISTER 7-16: IPC1: INTERRUPT PRIORITY CONTROL REGISTER 1

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	T2IP<2:0>			—	OC2IP<2:0>		
bit 15				bit 8			

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	IC2IP<2:0>			—	DMA0IP<2:0>		
bit 7				bit 0			

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **T2IP<2:0>:** Timer2 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•  
•  
•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **OC2IP<2:0>:** Output Compare Channel 2 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•  
•  
•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **IC2IP<2:0>:** Input Capture Channel 2 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•  
•  
•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as '0'

bit 2-0 **DMA0IP<2:0>:** DMA Channel 0 Data Transfer Complete Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•  
•  
•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

# dsPIC33FJXXGPX06A/X08A/X10A

## REGISTER 7-26: IPC11: INTERRUPT PRIORITY CONTROL REGISTER 11

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	T6IP<2:0>			—	DMA4IP<2:0>		
bit 15				bit 8			

U-0	U-0	U-0	U-0	U-0	R/W-1	R/W-0	R/W-0
—	—	—	—	—	OC8IP<2:0>		
bit 7					bit 0		

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **T6IP<2:0>:** Timer6 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **DMA4IP<2:0>:** DMA Channel 4 Data Transfer Complete Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 7-3 **Unimplemented:** Read as '0'

bit 2-0 **OC8IP<2:0>:** Output Compare Channel 8 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

# dsPIC33FJXXXGPX06A/X08A/X10A

**REGISTER 10-3: PMD3: PERIPHERAL MODULE DISABLE CONTROL REGISTER 3**

R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0
T9MD	T8MD	T7MD	T6MD	—	—	—	—
bit 15				bit 8			

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
—	—	—	—	—	—	I2C2MD	AD2MD <sup>(1)</sup>
bit 7						bit 0	

**Legend:**

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

- bit 15      **T9MD:** Timer9 Module Disable bit  
                  1 = Timer9 module is disabled  
                  0 = Timer9 module is enabled
- bit 14      **T8MD:** Timer8 Module Disable bit  
                  1 = Timer8 module is disabled  
                  0 = Timer8 module is enabled
- bit 13      **T7MD:** Timer7 Module Disable bit  
                  1 = Timer7 module is disabled  
                  0 = Timer7 module is enabled
- bit 12      **T6MD:** Timer6 Module Disable bit  
                  1 = Timer6 module is disabled  
                  0 = Timer6 module is enabled
- bit 11-2    **Unimplemented:** Read as '0'
- bit 1        **I2C2MD:** I2C2 Module Disable bit  
                  1 = I2C2 module is disabled  
                  0 = I2C2 module is enabled
- bit 0        **AD2MD:** AD2 Module Disable bit<sup>(1)</sup>  
                  1 = AD2 module is disabled  
                  0 = AD2 module is enabled

**Note 1:** PCFGx bits have no effect if ADC module is disabled by setting this bit. In this case all port pins multiplexed with ANx will be in Digital mode.

# dsPIC33FJXXXGPX06A/X08A/X10A

## 16.3 SPI Control Registers

REGISTER 16-1: SPIxSTAT: SPIx STATUS AND CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
SPIEN	—	SPISIDL	—	—	—	—	—
bit 15							bit 8

U-0	R/C-0	U-0	U-0	U-0	U-0	R-0	R-0
—	SPIROV	—	—	—	—	SPITBF	SPIRBF
bit 7							bit 0

<b>Legend:</b>	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15	<b>SPIEN:</b> SPIx Enable bit 1 = Enables module and configures SCKx, SDOx, SDIx and $\overline{SSx}$ as serial port pins 0 = Disables module
bit 14	<b>Unimplemented:</b> Read as '0'
bit 13	<b>SPISIDL:</b> Stop in Idle Mode bit 1 = Discontinue module operation when device enters Idle mode 0 = Continue module operation in Idle mode
bit 12-7	<b>Unimplemented:</b> Read as '0'
bit 6	<b>SPIROV:</b> Receive Overflow Flag bit 1 = A new byte/word is completely received and discarded. The user software has not read the previous data in the SPIxBUF register 0 = No overflow has occurred
bit 5-2	<b>Unimplemented:</b> Read as '0'
bit 1	<b>SPITBF:</b> SPIx Transmit Buffer Full Status bit 1 = Transmit not yet started, SPIxTXB is full 0 = Transmit started, SPIxTXB is empty Automatically set in hardware when CPU writes SPIxBUF location, loading SPIxTXB. Automatically cleared in hardware when SPIx module transfers data from SPIxTXB to SPIxSR.
bit 0	<b>SPIRBF:</b> SPIx Receive Buffer Full Status bit 1 = Receive complete, SPIxRXB is full 0 = Receive is not complete, SPIxRXB is empty Automatically set in hardware when SPIx transfers data from SPIxSR to SPIxRXB. Automatically cleared in hardware when core reads SPIxBUF location, reading SPIxRXB.

# dsPIC33FJXXXGPX06A/X08A/X10A

## REGISTER 20-1: DCICON1: DCI CONTROL REGISTER 1

R/W-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
DCIEN	—	DCISIDL	—	DLOOP	CCKD	CCKE	COFSD
bit 15							bit 8

R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0
UNFM	CSDOM	DJST	—	—	—	COFSM<1:0>	
bit 7							bit 0

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

- bit 15 **DCIEN:** DCI Module Enable bit  
1 = Module is enabled  
0 = Module is disabled
- bit 14 **Unimplemented:** Read as '0'
- bit 13 **DCISIDL:** DCI Stop in Idle Control bit  
1 = Module will halt in CPU Idle mode  
0 = Module will continue to operate in CPU Idle mode
- bit 12 **Unimplemented:** Read as '0'
- bit 11 **DLOOP:** Digital Loopback Mode Control bit  
1 = Digital Loopback mode is enabled. CSDI and CSDO pins internally connected  
0 = Digital Loopback mode is disabled
- bit 10 **CCKD:** Sample Clock Direction Control bit  
1 = CCK pin is an input when DCI module is enabled  
0 = CCK pin is an output when DCI module is enabled
- bit 9 **CCKE:** Sample Clock Edge Control bit  
1 = Data changes on serial clock falling edge, sampled on serial clock rising edge  
0 = Data changes on serial clock rising edge, sampled on serial clock falling edge
- bit 8 **COFSD:** Frame Synchronization Direction Control bit  
1 = COFS pin is an input when DCI module is enabled  
0 = COFS pin is an output when DCI module is enabled
- bit 7 **UNFM:** Underflow Mode bit  
1 = Transmit last value written to the transmit registers on a transmit underflow  
0 = Transmit '0's on a transmit underflow
- bit 6 **CSDOM:** Serial Data Output Mode bit  
1 = CSDO pin will be tri-stated during disabled transmit time slots  
0 = CSDO pin drives '0's during disabled transmit time slots
- bit 5 **DJST:** DCI Data Justification Control bit  
1 = Data transmission/reception is begun during the same serial clock cycle as the frame synchronization pulse  
0 = Data transmission/reception is begun one serial clock cycle after frame synchronization pulse
- bit 4-2 **Unimplemented:** Read as '0'
- bit 1-0 **COFSM<1:0>:** Frame Sync Mode bits  
11 = 20-bit AC-Link mode  
10 = 16-bit AC-Link mode  
01 = I<sup>2</sup>S Frame Sync mode  
00 = Multi-Channel Frame Sync mode

# dsPIC33FJXXXGPX06A/X08A/X10A

TABLE 22-2: CONFIGURATION BITS DESCRIPTION

Bit Field	Register	RTSP Effect	Description
BWRP	FBS	Immediate	Boot Segment Program Flash Write Protection 1 = Boot segment may be written 0 = Boot segment is write-protected
BSS<2:0>	FBS	Immediate	Boot Segment Program Flash Code Protection Size x11 = No Boot program Flash segment  Boot space is 1K IW less VS 110 = Standard security; boot program Flash segment starts at End of VS, ends at 0007FEh 010 = High security; boot program Flash segment starts at End of VS, ends at 0007FEh  Boot space is 4K IW less VS 101 = Standard security; boot program Flash segment starts at End of VS, ends at 001FFEh 001 = High security; boot program Flash segment starts at End of VS, ends at 001FFEh  Boot space is 8K IW less VS 100 = Standard security; boot program Flash segment starts at End of VS, ends at 003FFEh 000 = High security; boot program Flash segment starts at End of VS, ends at 003FFEh
RBS<1:0>	FBS	Immediate	Boot Segment RAM Code Protection 11 = No Boot RAM defined 10 = Boot RAM is 128 Bytes 01 = Boot RAM is 256 Bytes 00 = Boot RAM is 1024 Bytes
SWRP	FSS	Immediate	Secure Segment Program Flash Write Protection 1 = Secure segment may be written 0 = Secure segment is write-protected

# dsPIC33FJXXGPX06A/X08A/X10A

## 22.4 Watchdog Timer (WDT)

For dsPIC33FJXXGPX06A/X08A/X10A devices, the WDT is driven by the LPRC oscillator. When the WDT is enabled, the clock source is also enabled.

The nominal WDT clock source from LPRC is 32 kHz. This feeds a prescaler and then can be configured for either 5-bit (divide-by-32) or 7-bit (divide-by-128) operation. The prescaler is set by the WDTPRE Configuration bit. With a 32 kHz input, the prescaler yields a nominal WDT time-out period (TWDT) of 1 ms in 5-bit mode, or 4 ms in 7-bit mode.

A variable postscaler divides down the WDT prescaler output and allows for a wide range of time-out periods. The postscaler is controlled by the WDTPOST<3:0> Configuration bits (FWDT<3:0>) which allow the selection of a total of 16 settings, from 1:1 to 1:32,768. Using the prescaler and postscaler, time-out periods ranging from 1 ms to 131 seconds can be achieved.

The WDT, prescaler and postscaler are reset:

- On any device Reset
- On the completion of a clock switch, whether invoked by software (i.e., setting the OSWEN bit after changing the NOSC bits) or by hardware (i.e., Fail-Safe Clock Monitor)
- When a PWRSAV instruction is executed (i.e., Sleep or Idle mode is entered)
- When the device exits Sleep or Idle mode to resume normal operation
- By a CLRWDT instruction during normal execution

If the WDT is enabled, it will continue to run during Sleep or Idle modes. When the WDT time-out occurs, the device will wake the device and code execution will continue from where the PWRSAV instruction was executed. The corresponding SLEEP or IDLE bits (RCON<3,2>) will need to be cleared in software after the device wakes up.

The WDT flag bit, WDTO (RCON<4>), is not automatically cleared following a WDT time-out. To detect subsequent WDT events, the flag must be cleared in software.

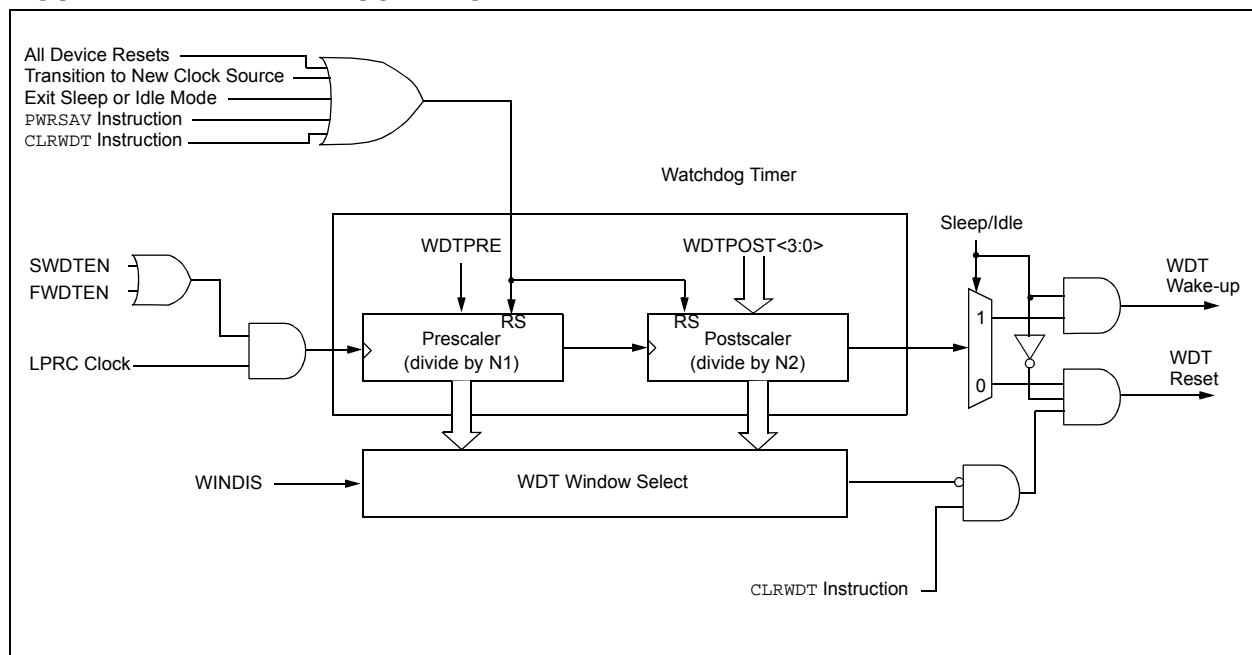
**Note:** The CLRWDT and PWRSAV instructions clear the prescaler and postscaler counts when executed.

The WDT is enabled or disabled by the FWDTEN Configuration bit in the FWDT Configuration register. When the FWDTEN Configuration bit is set, the WDT is always enabled.

The WDT can be optionally controlled in software when the FWDTEN Configuration bit has been programmed to '0'. The WDT is enabled in software by setting the SWDTEN control bit (RCON<5>). The SWDTEN control bit is cleared on any device Reset. The software WDT option allows the user to enable the WDT for critical code segments and disable the WDT during non-critical segments for maximum power savings.

**Note:** If the WINDIS bit (FWDT<6>) is cleared, the CLRWDT instruction should be executed by the application software only during the last 1/4 of the WDT period. This CLRWDT window can be determined by using a timer. If a CLRWDT instruction is executed before this window, a WDT Reset occurs.

FIGURE 22-2: WDT BLOCK DIAGRAM



## 24.0 DEVELOPMENT SUPPORT

The PIC® microcontrollers and dsPIC® digital signal controllers are supported with a full range of software and hardware development tools:

- Integrated Development Environment
  - MPLAB® IDE Software
- Compilers/Assemblers/Linkers
  - MPLAB C Compiler for Various Device Families
  - HI-TECH C® for Various Device Families
  - MPASM™ Assembler
  - MPLINK™ Object Linker/  
MPLIB™ Object Librarian
  - MPLAB Assembler/Linker/Librarian for Various Device Families
- Simulators
  - MPLAB SIM Software Simulator
- Emulators
  - MPLAB REAL ICE™ In-Circuit Emulator
- In-Circuit Debuggers
  - MPLAB ICD 3
  - PICKit™ 3 Debug Express
- Device Programmers
  - PICKit™ 2 Programmer
  - MPLAB PM3 Device Programmer
- Low-Cost Demonstration/Development Boards, Evaluation Kits, and Starter Kits

## 24.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8/16/32-bit microcontroller market. The MPLAB IDE is a Windows® operating system-based application that contains:

- A single graphical interface to all debugging tools
  - Simulator
  - Programmer (sold separately)
  - In-Circuit Emulator (sold separately)
  - In-Circuit Debugger (sold separately)
- A full-featured editor with color-coded context
- A multiple project manager
- Customizable data windows with direct edit of contents
- High-level source code debugging
- Mouse over variable inspection
- Drag and drop variables from source to watch windows
- Extensive on-line help
- Integration of select third party tools, such as IAR C Compilers

The MPLAB IDE allows you to:

- Edit your source files (either C or assembly)
- One-touch compile or assemble, and download to emulator and simulator tools (automatically updates all project information)
- Debug using:
  - Source files (C or assembly)
  - Mixed C and assembly
  - Machine code

MPLAB IDE supports multiple debugging tools in a single development paradigm, from the cost-effective simulators, through low-cost in-circuit debuggers, to full-featured emulators. This eliminates the learning curve when upgrading to tools with increased flexibility and power.



# dsPIC33FJXXXGPX06A/X08A/X10A

**TABLE 25-4: DC TEMPERATURE AND VOLTAGE SPECIFICATIONS**

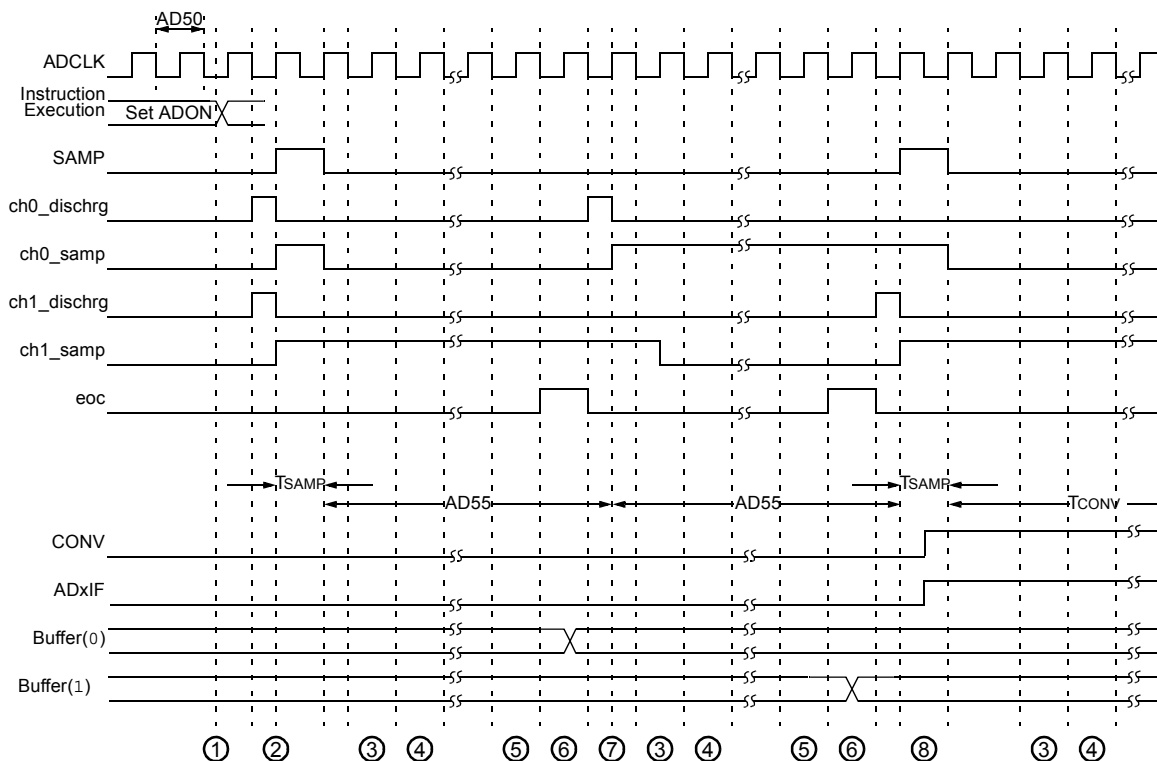
DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for Extended				
Param No.	Symbol	Characteristic	Min	Typ <sup>(1)</sup>	Max	Units	Conditions
<b>Operating Voltage</b>							
DC10	<b>Supply Voltage</b>						
	VDD	—	3.0	—	3.6	V	—
DC12	VDR	<b>RAM Data Retention Voltage<sup>(2)</sup></b>	1.8	—	—	V	—
DC16	VPOR	<b>VDD Start Voltage</b> to ensure internal Power-on Reset signal	—	—	VSS	V	—
DC17	SVDD	<b>VDD Rise Rate</b> to ensure internal Power-on Reset signal	0.03	—	—	V/ms	0-3.0V in 0.1s

**Note 1:** Data in “Typ” column is at 3.3V, 25°C unless otherwise stated.

**2:** This is the limit to which VDD can be lowered without losing RAM data.

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**FIGURE 25-26: ADC CONVERSION (10-BIT MODE) TIMING CHARACTERISTICS (CHPS<1:0> = 01, SIMSAM = 0, ASAM = 1, SSRC<2:0> = 111, SAMC<4:0> = 00001)**



- |   |   |
|---|---|
| ① – Software sets ADxCON. ADON to start AD operation.   | ⑤ – Convert bit 0.                          |
| ② – Sampling starts after discharge period.<br>TSAMP is described in <b>Section 16. “Analog-to-Digital Converter (ADC)”</b> (DS70183) in the “dsPIC33F/PIC24H Family Reference Manual”. | ⑥ – One TAD for end of conversion.          |
| ③ – Convert bit 9.  | ⑦ – Begin conversion of next channel.       |
| ④ – Convert bit 8.  | ⑧ – Sample for time specified by SAMC<4:0>. |

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**TABLE 25-45: ADC CONVERSION (10-BIT MODE) TIMING REQUIREMENTS**

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	Symbol	Characteristic	Min.	Typ <sup>(1)</sup>	Max.	Units	Conditions
<b>Clock Parameters</b>							
AD50b	TAD	ADC Clock Period	76	—	—	ns	—
AD51b	TRC	ADC Internal RC Oscillator Period	—	250	—	ns	—
<b>Conversion Rate</b>							
AD55b	TCONV	Conversion Time	—	12 TAD	—	—	—
AD56b	FCNV	Throughput Rate	—	—	1.1	Msps	—
AD57b	TSAMP	Sample Time	2 TAD	—	—	—	—
<b>Timing Parameters</b>							
AD60b	TPCS	Conversion Start from Sample Trigger <sup>(2)</sup>	2.0 TAD	—	3.0 TAD	—	Auto-Convert Trigger (SSRC<2:0> = 111) not selected
AD61b	TPSS	Sample Start from Setting Sample (SAMP) bit <sup>(2)</sup>	2.0 TAD	—	3.0 TAD	—	—
AD62b	TCSS	Conversion Completion to Sample Start (ASAM = 1) <sup>(2)</sup>	—	0.5 TAD	—	—	—
AD63b	TDPV	Time to Stabilize Analog Stage from ADC Off to ADC On <sup>(2,3)</sup>	—	—	20	μs	—

**Note 1:** These parameters are characterized but not tested in manufacturing.

**2:** Because the sample caps will eventually lose charge, clock rates below 10 kHz can affect linearity performance, especially at elevated temperatures.

**3:** TDPV is the time required for the ADC module to stabilize when it is turned on (AD1CON1<ADON> = 1). During this time, the ADC result is indeterminate.

**TABLE 25-46: DMA READ/WRITE TIMING REQUIREMENTS**

AC CHARACTERISTICS		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended					
Param No.	Characteristic	Min.	Typ	Max.	Units	Conditions	
DM1a	DMA Read/Write Cycle Time	—	—	2 TCY	ns	This characteristic applies to dsPIC33FJ256GPX06A/X08A/X10A devices only.	
DM1b	DMA Read/Write Cycle Time	—	—	1 TCY	ns	This characteristic applies to all devices with the exception of the dsPIC33FJ256GPX06A/X08A/X10A.	

# dsPIC33FJXXXGPX06A/X08A/X10A

**TABLE 26-12: SPIx MODULE SLAVE MODE (CKE = 0) TIMING REQUIREMENTS**

AC CHARACTERISTICS		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +150^{\circ}\text{C}$ for High Temperature					
Param No.	Symbol	Characteristic <sup>(1)</sup>	Min	Typ	Max	Units	Conditions
HSP35	Tsch2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge	—	—	35	ns	—
HSP40	TdiV2scH, TdiV2scL	Setup Time of SDIx Data Input to SCKx Edge	25	—	—	ns	—
HSP41	Tsch2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	25	—	—	ns	—
HSP51	TssH2doZ	$\overline{\text{SSx}}$ $\uparrow$ to SDOx Output High-Impedance	15	—	55	ns	See <b>Note 2</b>

**Note 1:** These parameters are characterized but not tested in manufacturing.

**2:** Assumes 50 pF load on all SPIx pins.

**TABLE 26-13: SPIx MODULE SLAVE MODE (CKE = 1) TIMING REQUIREMENTS**

AC CHARACTERISTICS		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +150^{\circ}\text{C}$ for High Temperature					
Param No.	Symbol	Characteristic <sup>(1)</sup>	Min	Typ	Max	Units	Conditions
HSP35	Tsch2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge	—	—	35	ns	—
HSP40	TdiV2scH, TdiV2scL	Setup Time of SDIx Data Input to SCKx Edge	25	—	—	ns	—
HSP41	Tsch2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	25	—	—	ns	—
HSP51	TssH2doZ	$\overline{\text{SSx}}$ $\uparrow$ to SDOx Output High-Impedance	15	—	55	ns	See <b>Note 2</b>
HSP60	TssL2doV	SDOx Data Output Valid after $\overline{\text{SSx}}$ Edge	—	—	55	ns	—

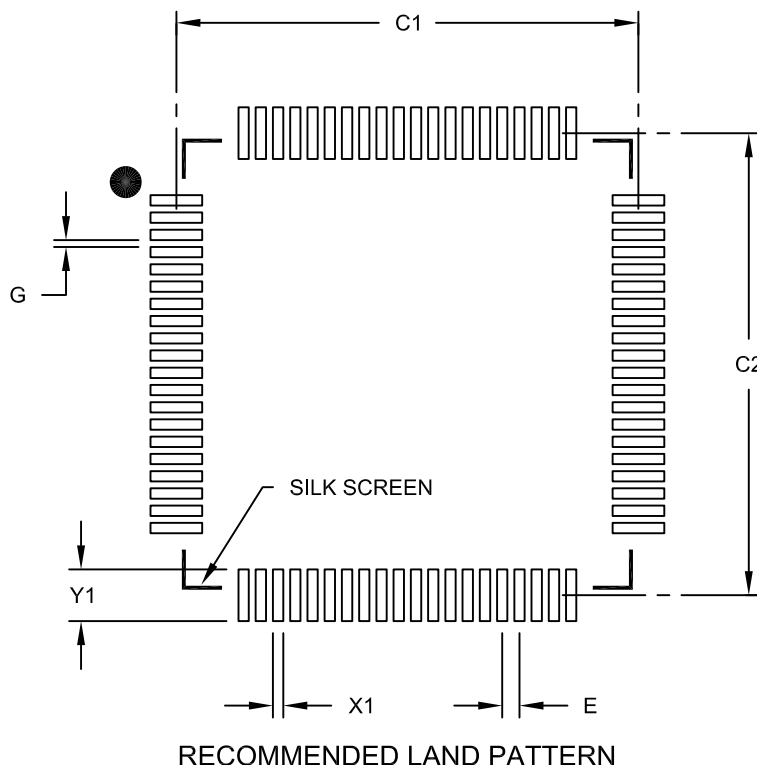
**Note 1:** These parameters are characterized but not tested in manufacturing.

**2:** Assumes 50 pF load on all SPIx pins.

# dsPIC33FJXXXGPX06A/X08A/X10A

80-Lead Plastic Thin Quad Flatpack (PT) - 12x12x1mm Body, 2.00 mm Footprint [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Contact Pitch	E	0.50 BSC		
Contact Pad Spacing	C1		13.40	
Contact Pad Spacing	C2		13.40	
Contact Pad Width (X80)	X1			0.30
Contact Pad Length (X80)	Y1			1.50
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2092B